

ASSIGNMENT

In consideration of value received, I, having a residence and post office address as stated below next to my name, the sole inventor (if only one name is listed below) or a joint inventor (if plural inventors are listed below) of an invention described in International Patent Application PCT/EP2005/002832 filed 17 MAR. 2005 and entitled

METHOD AND ARRANGEMENT FOR COOLING A SUBSTRATE, ESPECIALLY A SEMICONDUCTOR

sell and assign to ebm-papst St. Georgen GmbH & Co. KG
a German limited
partnership
having a business address at Hermann-Papst-Strasse 1
 D-78112 St. Georgen
 FED. REP. GERMANY

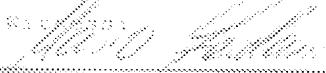
its successors, assigns or nominees, hereinafter referred to as "Assignee", my entire right, title and interest in and to said invention as disclosed, shown and described in said International Application PCT/EP2005/002832

and in and to all applications for patent and patents for said invention, in all countries of the world, including all divisions, reissues, continuations, substitutions and extensions thereof and all rights arising under or pursuant to any and all international agreements, treaties or laws relating to the protection of industrial property, including rights of priority, resulting from the filing of any of said applications; and I authorize and request any official whose duty is to issue patents, to issue any patent on said invention or resulting therefrom to said Assignee, and I agree that on request and without further consideration, but at the expense of said Assignee, I will communicate to said Assignee or its representatives all facts known to me respecting said invention and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuing, reissue, or other applications, make all rightful oaths and declarations, and generally do everything possible to aid said Assignee to obtain and enforce proper patent protection for said invention in all countries.

I hereby grant, to any attorney member of the following law firm, the power to insert, on this Assignment, the U.S. Serial number and U.S. filing date of said application, when known.

Serial Number: 10/699,261 Filing Date: 25 SEP. 2006

Ware, Frassola, Van der Slays & Adelphia LLP, 733 Main Street,
P.O. Box 224, Monroe, CT 06468

INVENTOR SIGNATURE	RESIDENCE AND POST OFFICE ADDRESS	
		Sommerauer Str. 43 D-78112 St. Georgen GERMANY
Type: Walter Georg ANGELIS		
NOTE: MUST BE DATED	BITTERER DENTRANCE	LEGALIZATION NOT REQUIRED.

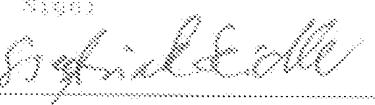
INVENTOR SIGNATURE

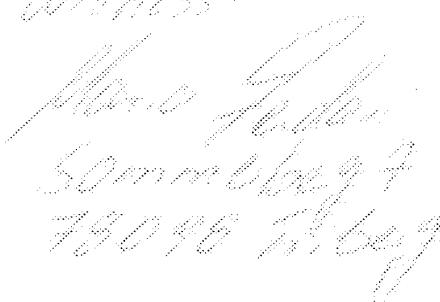
RESIDENCE AND POST OFFICE ADDRESS

Signer: 	Date: 25th Sept 2006	Bühlen 8 D-78733 Aichhalden GERMANY
Type: Wolfgang LAUFER		
NOTES: MUST BE DATED WITNESS SIGNATURE		LEGALIZATION NOT REQUIRED.

INVENTOR SIGNATURE

RESIDENCE AND POST OFFICE ADDRESS

Signer: 	Date: 25th Sept 2006	Kornblumenweg 61 D-78056 Villingen- Schwenningen GERMANY
Type: Siegfried SCHREIBER		
NOTES: MUST BE DATED WITNESS SIGNATURE		LEGALIZATION NOT REQUIRED.

Witness:

 Wolfgang Lauffer
 Kornblumenweg 8
 78046 Freiburg